PATENT ABSTRACTS OF JAPAN

(11)Publication number:

63-151034

(43) Date of publication of application: 23.06.1988

(51)Int.CI.

⊭01L 21/66 H01L 29/84

(21)Application number: **61-299360**

(71)Applicant:

NEC CORP

(22) Date of filing:

16.12.1986

(72)Inventor:

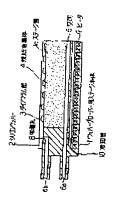
HISHII TOSHISUKE

(54) STAGE FOR SEMICONDUCTOR WAFER PROBER

(57)Abstract:

PURPOSE: To make it possible to measure the pressure sensitivity characteristic of a semiconductor pressure sensor in a wafer state, by providing a porous sintered metal body having air holes communicated to the cavity of the main body of a stage, a sucking hole for sucking the surface of a wafer, and a temperature control mechanism.

CONSTITUTION: When the pressure sensitivity characteristic of a semiconductor pressure sensor is measured, a silicon wafer 2, on which circuits and diaphragms are formed, is mounted on a stage surface 1a. A diaphragm part 3 thereof is aligned with a sintered metal body 4. When evacuation is performed through a cavity 5, a vacuum pressure is supplied to the diaphragm part 3 through the sintered metal body 4 having countless air holes. The silicon wafer 2 is fixed to the stage surface 1a by the evacuation through a sucking hole 8. The temperature of the stage surface 1a is adjusted by current conduction to a heater 9 or by sending refrigerant into a cooling pipe 10. Thus the pressure sensitivity of the semiconductor pressure sensor is measured, the pressure sensitivity characteristic of the semiconductor pressure sensor can be measured in a wafer state without separating the semiconductor wafer into chips and without assembling stems.



LEGAL STATUS

[Date of request for examination]

[Date of sending the examiner's decision of rejection]

[Kind of final disposal of application other than the examiner's decision of rejection or application converted registration]

[Date of final disposal for application]

[Patent number]

[Date of registration]

[Number of appeal against examiner's decision of rejection]

[Date of requesting appeal against examiner's decision of

rejection]

[Date of extinction of right]

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